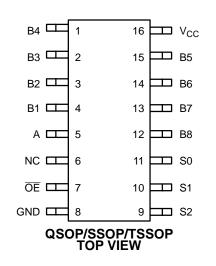
8:1 Multiplexer/ Demultiplexer Bus Switch

The ON Semiconductor 74FST3251 is an 8:1, high performance multiplexer/demultiplexer bus switch. The device is CMOS TTL compatible when operating between 4 and 5.5 Volts. The device exhibits extremely low R_{ON} and adds nearly zero propagation delay. The device adds no noise or ground bounce to the system.

- $R_{ON} < 4 \Omega$ Typical
- Less Than 0.25 ns–Max Delay Through Switch
- Nearly Zero Standby Current
- No Circuit Bounce
- Control Inputs are TTL/CMOS Compatible
- All Popular Packages: QSOP-16, TSSOP-16, SOIC-16



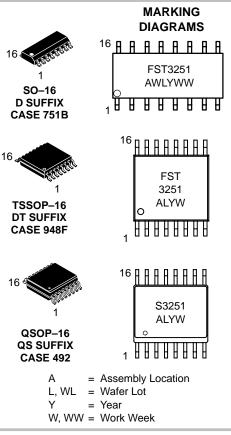
	Inputs			
OE	S2	S1	S0	Function
L	L	L	L	A Port = B1 Port
L	L	L	Н	A Port = B2 Port
L	L	Н	L	A Port = B3 Port
L	L	Н	Н	A Port = B4 Port
L	Н	L	L	A Port = B5 Port
L	Н	L	Н	A Port = B6 Port
L	Н	н	L	A Port = B7 Port
L	Н	Н	Н	A Port = B8 Port
н	Х	Х	Х	Disconnect

NOTE: H = HIGH Voltage Level, L = LOW Voltage Level, X = Don't Care



ON Semiconductor[™]

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PIN NAMES

Pin	Description
$\overline{OE}_1, \overline{OE}_2$	Bus Switch Enables
S ₀ , S ₁	Select Inputs
A	Bus A
B ₁ , B ₂ , B ₃ , B ₄	Bus B

ORDERING INFORMATION

Device	Package	Shipping
74FST3251D	SO-16	48 Units/Rail
74FST3251DR2	SO-16	2500 Units/Reel
74FST3251DT	TSSOP-16	96 Units/Rail
74FST3251DTR2	TSSOP-16	2500 Units/Reel
74FST3251QS	QSOP-16	96 Units/Rail
74FST3251QSR	QSOP-16	2500 Units/Reel

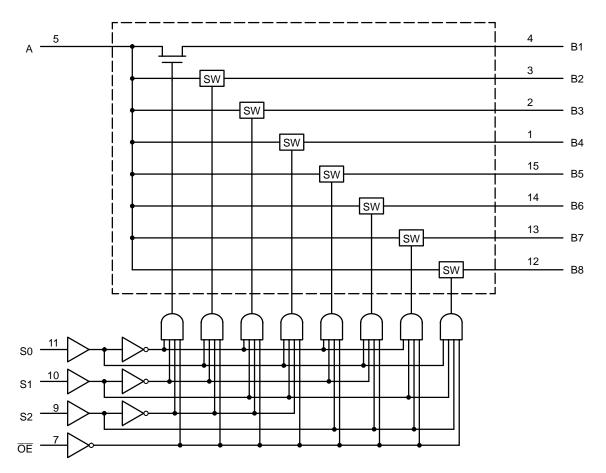


Figure 1. Logic Diagram

MAXIMUM RATINGS

Symbol	Par	rameter	Value	Unit
V _{CC}	DC Supply Voltage		-0.5 to +7.0	V
VI	DC Input Voltage		-0.5 to $+7.0$	V
V _O	DC Output Voltage		-0.5 to $+7.0$	V
I _{IK}	DC Input Diode Current	V _I < GND	-50	mA
I _{OK}	DC Output Diode Current	V _O < GND	-50	mA
I _O	DC Output Sink Current		128	mA
I _{CC}	DC Supply Current per Supply Pin		±100	mA
I _{GND}	DC Ground Current per Ground Pin		±100	mA
T _{STG}	Storage Temperature Range		-65 to +150	°C
TL	Lead Temperature, 1 mm from Case for	10 Seconds	260	°C
TJ	Junction Temperature Under Bias		+ 150	°C
θ_{JA}	Thermal Resistance	SOIC TSSOP QSOP	125 170 200	°C/W
MSL	Moisture Sensitivity		Level 1	
F _R	Flammability Rating	Oxygen Index: 28 to 34	UL 94 V–0 @ 0.125 in	
V _{ESD}	ESD Withstand Voltage	Human Body Model (Note 1) Machine Model (Note 2) Charged Device Model (Note 3)	>2000 >200 N/A	V
I _{LATCH-UP}	Latch–Up Performance A	bove V _{CC} and Below GND at 85°C (Note 4)	±500	mA

Maximum Ratings are those values beyond which damage to the device may occur. Exposure to these conditions or conditions beyond those indicated may adversely affect device reliability. Functional operation under absolute maximum–rated conditions is not implied. Functional operation should be restricted to the Recommended Operating Conditions.

1. Tested to EIA/JESD22-A114-A.

2. Tested to EIA/JESD22-A115-A.

3. Tested to JESD22-C101-A.

4. Tested to EIA/JESD78.

RECOMMENDED OPERATING CONDITIONS

Symbol	Р	Parameter			Unit
V _{CC}	Supply Voltage	Operating, Data Retention Only	4.0	5.5	V
VI	Input Voltage	(Note)	0	5.5	V
Vo	Output Voltage	(HIGH or LOW State)	0	5.5	V
T _A	Operating Free–Air Temperature		- 40	+ 85	°C
$\Delta t / \Delta V$	Input Transition Rise or Fall Rate Switch I/O	Switch Control Input V _{CC} = 5.0 V \pm 0.5 V	0	DC 5	ns/V

5. Unused control inputs may not be left open. All control inputs must be tied to a high or low logic input voltage level.

DC ELECTRICAL CHARACTERISTICS

			V _{CC}	$T_A = -40^{\circ}C \text{ to } +85^{\circ}C$			
Symbol	Parameter	Conditions	(V)	Min	Тур*	Max	Unit
V _{IK}	Clamp Diode Resistance	I _{IN} = -18mA	4.5			-1.2	V
V _{IH}	High–Level Input Voltage		4.0 to 5.5	2.0			V
V _{IL}	Low-Level Input Voltage		4.0 to 5.5			0.8	V
I _I	Input Leakage Current	$0 \le V_{IN} \le 5.5 V$	5.5			±1.0	μΑ
I _{OZ}	OFF–STATE Leakage Current	$0 \le A, B \le V_{CC}$	5.5			±1.0	μΑ
R _{ON}	Switch On Resistance (Note 6)	$V_{IN} = 0 V, I_{IN} = 64 mA$	4.5		4	7	Ω
		V _{IN} = 0 V, I _{IN} = 30 mA	4.5		4	7	1
		V _{IN} = 2.4 V, I _{IN} = 15 mA	4.5		8	15	1
		V _{IN} = 2.4 V, I _{IN} = 15 mA	4.0		11	20	1
I _{CC}	Quiescent Supply Current	$V_{IN} = V_{CC}$ or GND, $I_{OUT} = 0$	5.5			3	μA
ΔI_{CC}	Increase In I _{CC} per Input	One input at 3.4 V, Other inputs at V_{CC} or GND	5.5			2.5	mA

*Typical values are at V_{CC} = 5.0 V and T_A = 25°C.
6. Measured by the voltage drop between A and B pins at the indicated current through the switch. On resistance is determined by the lower of the voltages on the two (A or B) pins.

AC ELECTRICAL CHARACTERISTICS

			$T_A = -40$ °C to $+85$ °C C _L = 50 pF, RU = RD = 500 Ω) Ω		
			V _{CC} = 4	.5–5.5 V	V _{CC} =	4.0 V	
Symbol	Parameter	Conditions	Min	Max	Min	Max	Unit
t _{PHL} , t _{PLH}	Prop Delay Bus to Bus (Note 7)	V _I = OPEN		0.25		0.25	ns
	Prop Delay, Select to Bus A		1.0	6.3		6.9	
t _{PZH} , t _{PZL}	Output Enable Time, Select to Bus B	$V_I = 7 V$ for t_{PZL}	1.0	6.0		6.5	ns
	Output Enable Time, I _{OE} to Bus A, B	$V_I = OPEN \text{ for } t_{PZH}$	1.0	6.0		6.5	
t _{PHZ} , t _{PLZ}	Output Disable Time, Select to Bus B	$V_I = 7 V$ for t_{PLZ}	1.0	5.8		6.5	ns
	Output Disable Time, I_{OE} to Bus A, B	$V_I = OPEN \text{ for } t_{PHZ}$	1.0	5.8		6.5]

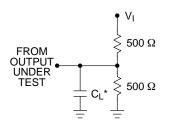
7. This parameter is guaranteed by design but is not tested. The bus switch contributes no propagation delay other than the RC delay of the typical On resistance of the switch and the 50 pF load capacitance, when driven by an ideal voltage source (zero output impedance).

CAPACITANCE (Note 8)

Symbol	Parameter	Conditions	Тур	Max	Unit
C _{IN}	Control Pin Input Capacitance	$V_{CC} = 5.0 V$	3		pF
C _{I/O}	A Port Input/Output Capacitance	$V_{CC}, \overline{OE} = 5.0 V$	13		pF
C _{I/O}	B Port Input/Output Capacitance	$V_{CC}, \overline{OE} = 5.0 \text{ V}$	5		pF

8. $T_A = +25^{\circ}C$, f = 1 MHz, Capacitance is characterized but not tested.

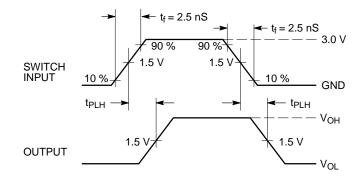
AC Loading and Waveforms

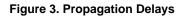


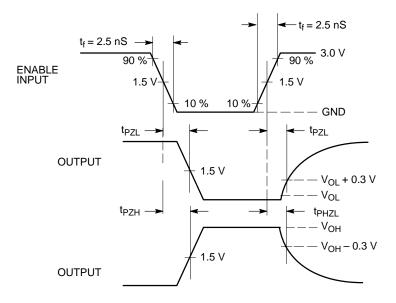
NOTES:

1. Input driven by 50 Ω source terminated in 50 $\Omega.$ 2. CL includes load and stray capacitance. $^{*}C_{L} = 50 \text{ pF}$



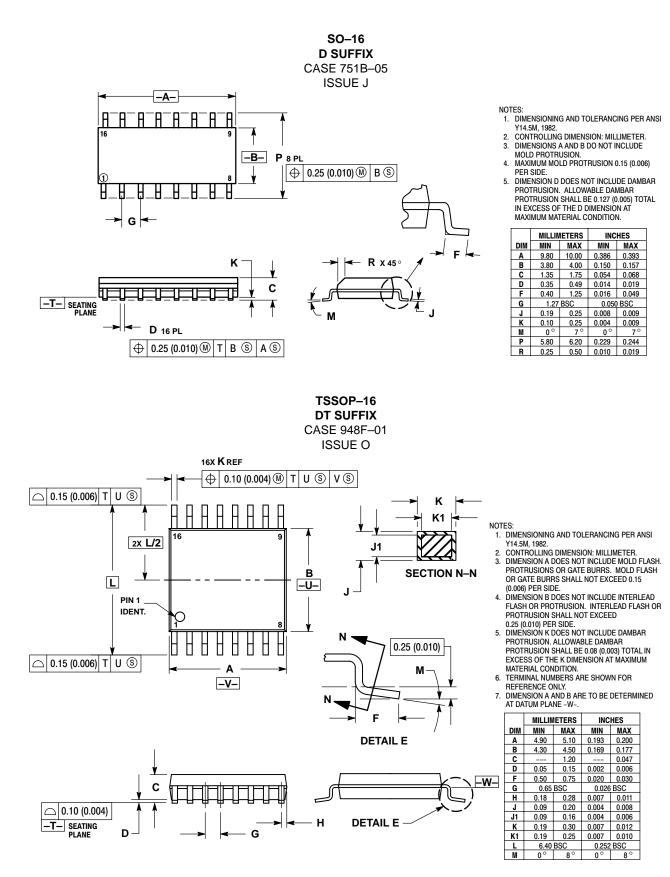




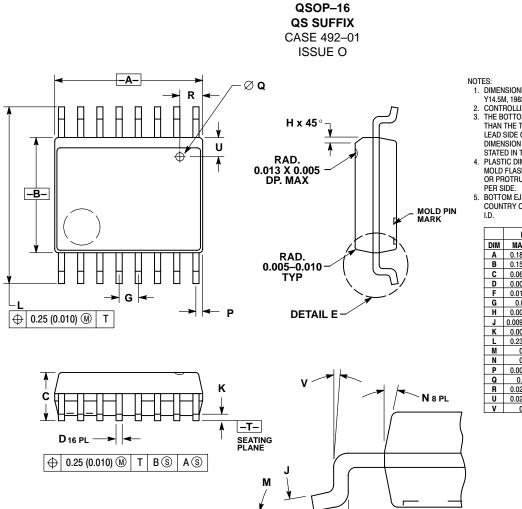




PACKAGE DIMENSIONS



PACKAGE DIMENSIONS



- NOTES: 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982. 2. CONTROLLING DIMENSION: INCH. 3. THE BOTTOM PACKAGE SHALL BE BIGGER THAN THE TOP PACKAGE BY 4 MILS (NOTE: LEAD SIDE ONLY). BOTTOM PACKAGE DIMENSION SHALL FOLLOW THE DIMENSION STATED IN THIS DRAWING. 4. PLASTIC DIMENSIONS DOES NOT INCLUDE MOLD FLASH OR PROTRUSIONS, MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 6 MILS PER SIDE. 5. BOTTOM EJECTOR PIN WILL INCLUDE THE
- 5. BOTTOM EJECTOR PIN WILL INCLUDE THE COUNTRY OF ORIGIN (COO) AND MOLD CAVITY I.D.

	INC	HES	MILLIMETERS			
DIM	MAX	MIN	MAX	MIN		
Α	0.189	0.196	4.80	4.98		
В	0.150	0.157	3.81	3.99		
С	0.061	0.068	1.55	1.73		
D	0.008	0.012	0.20	0.31		
F	0.016	0.035	0.41	0.89		
G	0.025	BSC	0.64	BSC		
н	0.008	0.018	0.20	0.46		
J	0.0098	0.0075	0.249	0.191		
Κ	0.004	0.010	0.10	0.25		
L	0.230	0.244	5.84	6.20		
М	0 °	8 °	0 °	8°		
Ν	0 °	7 °	0 °	7°		
Р	0.007	0.011	0.18	0.28		
Q	0.020	DIA	0.51	1 DIA		
R	0.025	0.035	0.64	0.89		
U	0.025	0.035	0.64	0.89		
V	0 °	8 °	0 °	8 °		

DETAIL E

F

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